

## Changes in the Nikkei High Dividend Yield 50 constituents

June 14, 2024 – Nikkei Inc. will change the Nikkei 225 High Dividend Yield Stock 50 Index (Nikkei High Dividend Yield 50) constituents as a result of the Periodic Review of 2024. The changes shown below will become effective from June 28. As 2 constituents were deleted after the last review, the current number of the constituents is 48. The number will be back to fifty after this reshuffle.

Date	Addition	Deletion
Jun. 28	1802 Obayashi Corp.	5020 ENEOS Holdings, Inc.
	4503 Astellas Pharma Inc.	7186 Concordia Financial Group, Ltd.
	6305 Hitachi Construction Machinery	8031 Mitsui & Co., Ltd.
	Co., Ltd.	8308 Resona Holdings, Inc.
	6471 NSK Ltd.	8354 Fukuoka Financial Group, Inc.
	6770 Alps Alpine Co., Ltd.	8604 Nomura Holdings, Inc.
	6952 Casio Computer Co., Ltd.	8795 T&D Holdings, Inc.
	7201 Nissan Motor Co., Ltd.	
	7267 Honda Motor Co., Ltd.	
	8252 Marui Group Co., Ltd.	

The Periodic Review was carried out by using the ranking of the Nikkei 225 constituents by Expected Dividend Yield (on Nikkei's forecasts) as of May 31 (Base Date). Higher yield non-constituents are added while lower yield current constituents are removed. The weighted average dividend yield of the index as of May 31 based on the new 50 constituents was 3.85%.

The <u>Nikkei High Dividend Yield 50 web page</u> provides detailed information on the index, such as index values, constituent weights and dividend yields

News Tag: NikkeiHighDividnedYield50, ComponentChange